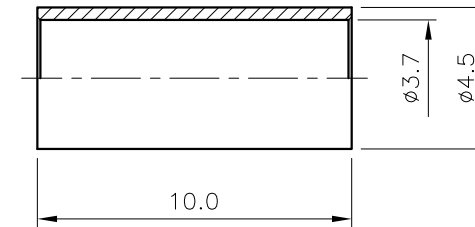
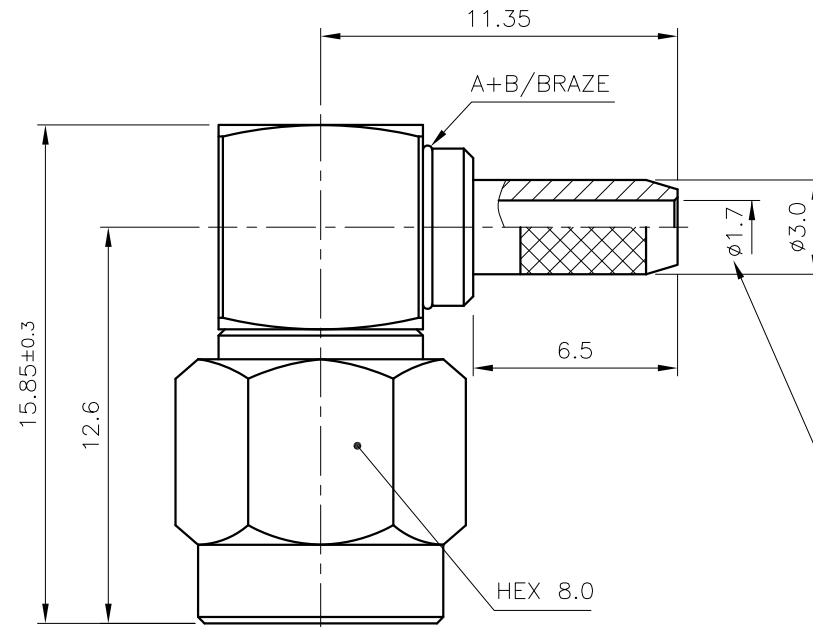
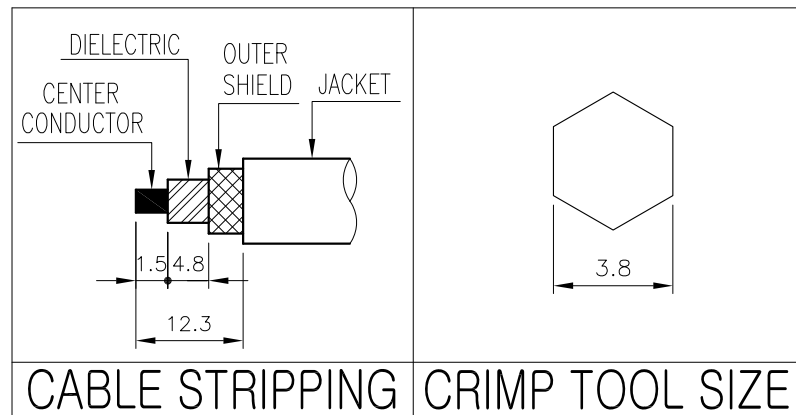


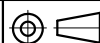
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2018.08.09.
i	바디 A+B 억지끼움 후 용접으로 치수 공차 변경	S.H.KIM		2023.06.21.



하이스핀 Ø1.7 삽입하여 전수 검사 할 것
(BODY 간 내부 은땜 흐름 및 뭍침 여부 확인)



8	SPRING RING	1	SUS304	Passivated	DSR00002-5/1
7	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00031-5/1
6	CAP	1	MBsBD C3604BD-F	Gold Plate	DCU00005-5/1
5	INSULATOR	1	TEFLON		DIN00090-N/1
4	GASKET	1	SILICONE RUB		DGK00004-N/1
3	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00043-5/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT00300-5/1
1	1-2	1	MBsBD C3604BD-F	Gold Plate	DBD01657-1/4
	1-1	1	MBsBD C3604BD-F	Gold Plate	DBD00027-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 06. 21.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL _____		CHECKED BY	TITLE SMA50 CABLE PL Fujikura 1.5D-HQEW			
		DRAWN BY				S.H.KIM
FINISH _____		SCALE 4/1	UNIT mm		A4	DWG NO. CN01092-7/3
						REVISION 1